

IEC 61249-8-8 Ed. 1.0 b:1997, Materials for interconnection structures - Part 8: Sectional specification set for non-conductive films and coatings - Section 8: Temporary polymer coatings



Provides requirements for the qualification of temporary solder resist coatings. Requirements stated in this specification will also have some limited validity for assessing the suitability of printed boards which are supplied with peelable solder masks.

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Materials for interconnection structures - Part 8: Sectional specification set for non-conductive films and coatings - Section 8: Temporary polymer coatings. Publication Year: 1997. Total Pages: 19. Publisher: IEC **DOC No** IEC 60044-4-8 IEC 60045-1 IEC 60050-101 IEC 60050-121 .. IEC 60076-4 2002-06-00 IEC 60076-5 IEC 60076-8 2000-07-00 1997-10-00 IEC .. Part 2: Sectional Specification: Fixed Low-Power Non-Wirewound Resistors First Edition.3: Permanent Polymer Coating Materials (Solder Resist) for Use in the **IEC???? - Microelectronics(3) - davycarl1981???** - **????** Open Document Architecture (ODA) and Interchange Format: Page 8 .Text and and Non-Linear Structures First Edition (DRAFT) Information Technology . 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